



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# # 20240729003.0
Top Side marking change for Select Devices
Information Only**

Date: July 30, 2024
To: MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the Change Management team.

Sincerely,

Change Management Team
SC Business Services

20240729003.0
Information Only
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
LPV802DGKR	NULL
LPV802DGKT	NULL
LPV812DGKR	NULL
LPV812DGKT	NULL
TLV8802DGKR	NULL
TLV8802DGKT	NULL
TLV8812DGKR	NULL

Technical details of this Product Change follow on the next page(s).

Notification Number:		20240729003.0		Notification Date:		July 30, 2024		
Title:		Top Side marking change for Select Devices						
Customer Contact:		Change Management team			Dept:		Quality Services	
Change Type:								
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material			
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process			
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site			
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Materials			
<input checked="" type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process			

Notification Details		
Description of Change:		
This notice is to communicate an update in MLA & TIEM device symbolization format for the devices in the product affected selection as follows:		
	Current	MLA/TIEM
Topside Marking (Sample)	+-----+	+-----+
	YM TI	TI YM
	LPV	L802
	802	
	O	O (CAV)
	+-----+	+-----+
Backside marking	+-----+	No
	! O YMS !	
	! LLLL !	
	+-----+	
Cavity number (CAV)	No	Yes

Device	Current	MLA/TIEM
LPV802DGKR	LPV802	L802
LPV802DGKT	LPV802	L802
TLV8812DGKR	TLV8812	8812
TLV8812DGKT	TLV8812	8812
LPV812DGKR	LPV812	812
LPV812DGKT	LPV812	812
TLV8802DGKR	TLV8802	8802
TLV8802DGKT	TLV8802	8802

Reason for Change:			
Marking Standardization			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
None			
Changes to product identification resulting from this notification:			
None.			
Product Affected:			
LPV802DGKR	TLV8812DGKR	LPV812DGKR	TLV8802DGKR

LPV802DGKT	TLV8812DGKT	LPV812DGKT	TLV8802DGKT
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For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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